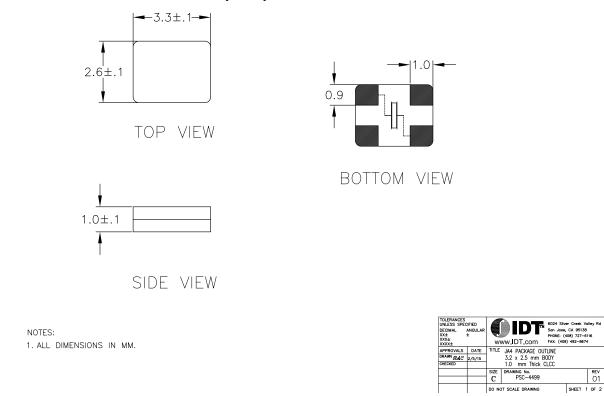


DATASHEET

Specifications

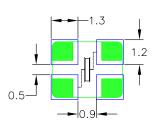
| Parameters | Ratings/Units | | | |
|---|--------------------|--|--|--|
| Frequency | 38.880 MHz | | | |
| Resonance Mode | Fundamental | | | |
| Frequency Tolerance @ 25°C | ±20 PPM Max | | | |
| Frequency Stability, ref @ 25°C Over Operating Temperature Range | ±20 PPM Max | | | |
| Temperature Range, Operating (TOPR) | -40°C ~ +85°C | | | |
| Temperature Range, Storage (TSTG) | -40°C ~ +85°C | | | |
| Equivalent Series Resistance (ESR) | 30 Ohms Max | | | |
| Shunt Capacitance (Co) | 5 pF Max | | | |
| Load Capacitance (CL) | 12 pF | | | |
| Drive Level | 0.3 mW Max | | | |
| Aging over 10 years | ±10 PPM Max | | | |
| Maximum Soldering Temp / Time | 260°C / 10 Seconds | | | |
| Moisture Sensitivity Level (MSL) | 1 | | | |
| Termination Finish: | Au | | | |
| Weight (TYP) | 16.75 mg | | | |
| RoHS Compliant, Pb-free | | | | |

Package Outline and Dimensions (JA4)





Package Outline and Dimensions (JA4), cont.



RECOMMENDED LAND PATTERN

NOTES:

- 1. ALL DIMENSION ARE IN mm. ANGLES IN DEGREES.
 2. TOP DOWN VIEW. AS VIEWED ON PCB.
 3. COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN.
 4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
 5. LAND PATTERN RECOMMENDATION PER IPC—7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

| TOLERANCES UNLESS SPE DECIMAL XX± XXX± XXXX± | | w w | IDT* | San Jose, PHONE: (4 | er Creek Vo CA 95138 08) 727-6) 492-8674 | 116 |
|---|--------|-------------------|------------------|------------------------|--|------|
| APPROVALS | DATE | TITLE | JA4 PACKAGE OUT | TLINE | | |
| DRAWN RAC | 2/5/15 | 3.2 x 2.5 mm B0DY | | | | |
| CHECKED | | 1.0 mm Thick CLCC | | | | |
| | | SIZE | DRAWING No. | | | REV |
| | | C | PSC-4499 | | | 01 |
| | | DO NO | OT SCALE DRAWING | | SHEET 2 | 0F 2 |

Ordering Information

| Part / Order Number | Shipping Packaging | Package | Temperature |
|---------------------|--------------------|-----------------------------|---------------|
| 603-38.88-7JA4I | Cut-Tape | 3.2 x 2.5 x 1.0 mm JA4 CLCC | -40 to +85 °C |
| 603-38.88-7JA4I8 | Tape and Reel | 3.2 x 2.5 x 1.0 mm JA4 CLCC | -40 to +85 °C |

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